

# **BAY73**

# **Small Signal Diode**



DO-35

# Absolute Maximum Ratings \* T<sub>a</sub> = 25°C unless otherwise noted

| Symbol             | Parameter  | Value       | Unit   |
|--------------------|--|-------------|--------|
| V <sub>RRM</sub>   | Maximum Repetitive Reverse Voltage   | 125         | V      |
| I <sub>F(AV)</sub> | Average Rectified Forward Current  | 500         | mA     |
| I <sub>FSM</sub>   | Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond | 1.0<br>4.0  | A<br>A |
| T <sub>STG</sub>   | Storage Temperature Range  | -65 to +200 | °C     |
| T <sub>J</sub>     | Operating Junction Temperature   | 175         | °C     |

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

### **Thermal Characteristics**

| Symbol          | Parameter                               | Value | Unit |
|-----------------|---|-------|------|
| $P_{D}$         | Power Dissipation                       | 500   | mW   |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 300   | °C/W |

## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Symbol          | Parameter             | Conditions  | Min.   | Max   | Units            |
|-----------------|-----------------------|---|--|---|------------------|
| V <sub>R</sub>  | Breakdown Voltage     | I <sub>R</sub> = 100μA  | 125  |   | V                |
| V <sub>F</sub>  | Forward Voltage       | $I_F = 1mA$ $I_F = 5mA$ $I_F = 10mA$ $I_F = 50mA$ $I_F = 100mA$ $I_F = 200mA$ | 0.60<br>0.67<br>0.69<br>0.78<br>0.81<br>0.85 | 0.68<br>0.75<br>0.80<br>0.88<br>0.94<br>1.0 | V<br>V<br>V<br>V |
| I <sub>R</sub>  | Reverse Leakage       | $V_R = 100V$<br>$V_R = 100V$ , $T_A = 125$ °C<br>$V_R = 20V$ , $T_A = 125$ °C |  | 5<br>1<br>500                               | nA<br>μA<br>nA   |
| $C_{T}$         | Total Capacitance     | $V_{R} = 0, f = 1.0MHz$   |  | 8   | pF               |
| t <sub>rr</sub> | Reverse Recovery Time | $I_F = I_R = 30 \text{mA}, I_{rr} = 3 \text{mA}, R_L = 100 \Omega$            |  | 1.0   | μs               |

 $<sup>\</sup>begin{tabular}{ll} \textbf{NOTES:}\\ \textbf{1)} \ These \ ratings \ are \ based \ on \ a \ maximum \ junction \ temperature \ of \ 200 \ degrees \ C. \end{tabular}$ 

<sup>2)</sup> These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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